

Specifications

Wafer

備注 (Remark)

1. 材料 (Material)

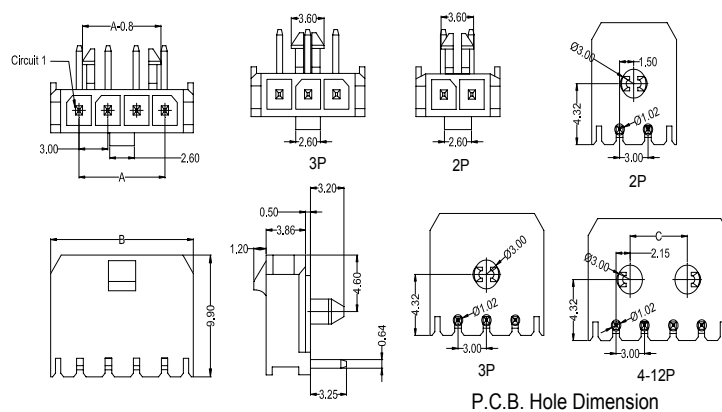
膠芯: LCP/PA66 UL94V-0

Housing: LCP/PA66 UL94V-0

端子: 黃銅

Contact: Brass

3025WR-XX-XXSN



3025WR-XX-XXSN

Poles	Dimensions (mm)		
	A	B	C
2	3.00	9.65	---
3	6.00	12.65	---
4	9.00	15.65	4.75
5	12.00	18.65	7.75
6	15.00	21.65	10.75
7	18.00	24.65	13.75
8	21.00	27.65	16.75
9	24.00	30.65	19.75
10	27.00	33.65	22.75
11	30.00	36.65	25.75
12	33.00	39.65	28.75

3025WR-XX-N0SN	PA66 UL 94V-0	Brass	Tin-Plated	3025H	1,000Pcs
3025WR-XX-LPSN	LCP UL 94V-0				
PART NO	Material	Material(Pin)	Finish(Pin)	Mates With SWB Housing	Q' ty/Bag

Housing

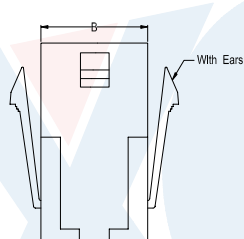
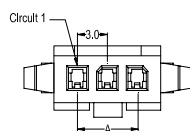
備注 (Remark)

1. 材料 (Material)

膠芯: PA66 UL94V-2

Housing: PA66 UL94V-2

3025HF-XXX-N2



3025HF-XXX-N2

Poles	Dimensions (mm)	
	A	B
2	3.00	6.90
3	6.00	9.90
4	9.00	12.90
5	12.00	15.90
6	15.00	18.90
7	18.00	21.90
8	21.00	24.90
9	24.00	27.90
10	27.00	30.90
11	30.00	33.90
12	33.00	36.90

3025HF-XXG-N2	Nylon 66 94V-2	3025TM	3025HM	With Ears	1,000Pcs
3025HF-XXI-N2	Nylon 66 94V-2			Without Ears	
PART NO	Material	Suitable SWB Terminal	Mates With SWB Housing	Note	Q' ty/Bag

Terminal

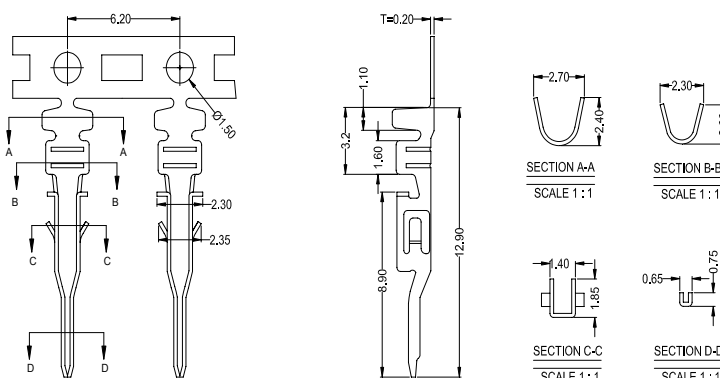
備注 (Remark)

1. 材料 (Material)

端子: 磷青銅

Contact: Phosphor bronze

3025TM-PXX



3025TM-PXX

3025TM-PG30	Phosphor Bronze	AWG#20-24	1.85mm(Max)	Stamping Before Plating: 30-50u" Ni; Contact Area Gold: 30u" Min.	3025HF	10,000Pcs
3025TM-PG15				Stamping Before Plating: 30-50u" Ni; Contact Area Gold: 15u" Min.		
3025TM-PG01				Stamping Before Plating: 30-50u" Ni; Contact Area Gold Flash		
3025TM-PSN				Stamping Before Plating: 30-50u" Ni; 70-120u" Sn		
PART NO	Material	Wire Range	Insulation O.D.	Finish	Used In SWB Housing	Q' ty/Reel